

Description

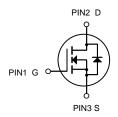
The Si2342DS-T1-GE3 uses advanced trench technology to provide excellent $R_{DS(ON)}$,low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

D. S.

SOT-23

General Features

 V_{DS} = 20V, I_D = 7A $R_{DS(ON)}$ < 17m Ω @ VGS=4.5V $R_{DS(ON)}$ < 25m Ω @ VGS=2.5V



N-Channel MOSFET

Application

High power and current handing capability
Lead free product is acquired
Surface mount package
PWM applications

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
Si2342DS-T1-GE3	SOT-23	HXY MOSFET	3000

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage	20	V
V _G S	Gate-Source Voltage	±12	V
I _D	Drain Current-Continuous	7	А
Ірм	Drain Current-Pulsed (Note 1)	32	А
Po	Maximum Power Dissipation	2	W
T _J ,T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$
Reja	Thermal Resistance,Junction-to-Ambient (Note 2)	120	°C/W

Electrical Characteristics (TJ=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	20	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V,	-	-	1.0	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±12V	-	-	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.75	1.2	V
D	Static Drain-Source on-Resistance	V _{GS} =4.5V, I _D =7A	-	15	17	0
$R_{DS(on)}$	note2	V _{GS} =2.5V, I _D =5A	-	19	25	mΩ
C _{iss}	Input Capacitance	14 4014 14 014	-	700	_	pF
Coss	Output Capacitance	V _{DS} =10V, V _{GS} =0V, f=1.0MHz	-	132	-	pF
C _{rss}	Reverse Transfer Capacitance	1-1.0WIFIZ	-	114	-	pF
Qg	Total Gate Charge	V _{DS} =10V, I _D =4A, V _{GS} =4.5V	-	15	-	nC
Qgs	Gate-Source Charge		-	2	-	nC
Q_{gd}	Gate-Drain("Miller") Charge	VGS-4.5V	-	5.2	-	nC
t _{d(on)}	Turn-on Delay Time) / 40) /	-	9	_	ns
t _r	Turn-on Rise Time	V _{DS} =10V,	-	25	-	ns
$t_{d(off)}$	Turn-off Delay Time	I_D =4A, R_{GEN} =3 Ω , V_{GS} =4.5 V	-	37	-	ns
t _f	Turn-off Fall Time	VGS-4.5V	-	14	-	ns
	Maximum Continuous Drain to Source Diode Forward Current				7.5	^
Is			-	-	7.5	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	32	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =8A	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

^{2.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

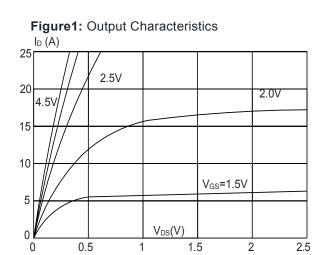


Figure 2: Typical Transfer Characteristics

25

20

15

10

5

125°C

25°C

0

0

0

0

0

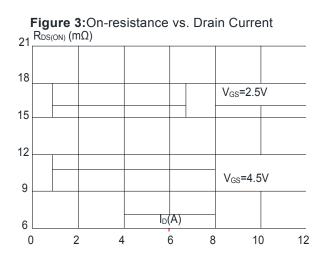
0

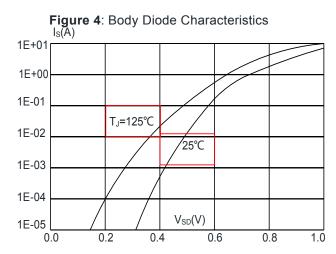
1.5

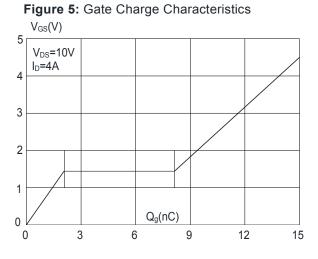
2.0

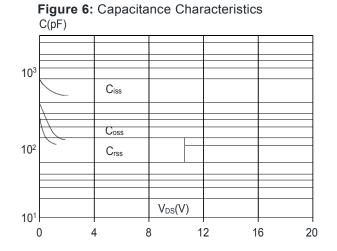
2.5

3.0









Junction Temperature

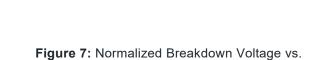


Figure 9: Maximum Safe Operating Area

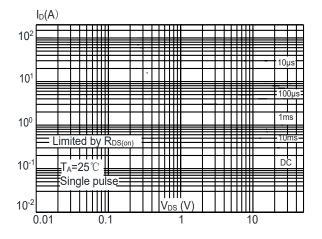


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

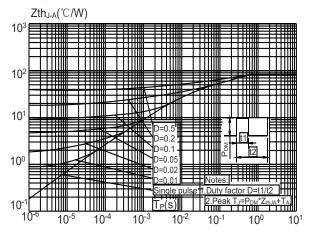


Figure 8: Normalized on Resistance vs. Junction Temperature

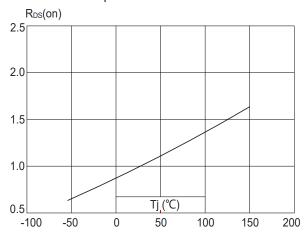
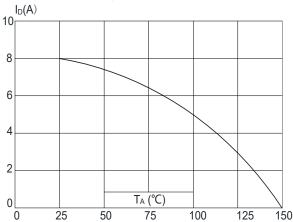
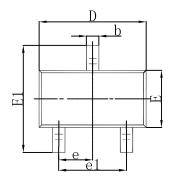


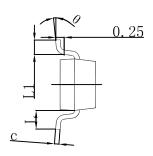
Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

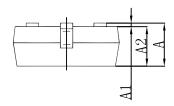




SOT-23 Package Outline Dimensions

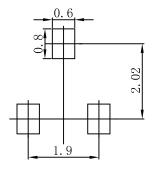






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
 3.The pad layout is for reference purposes only.



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